



Product Change Notification

Change Notification #: 115793 - 00

**Change Title: Intel® RAID Controller RMS3JC080,
PCN 115793-00, Product Design, Product Material,
Firmware and standoffs upgrade**

Date of Publication: August 31, 2017

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Sep 18, 2017
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following change on the Intel® RAID Module RS3JC080:

- Upgrade the controller's firmware version 12.00.02.00 (Phase 12).
- Upgrade to the stand-offs which include a pull tab for easier removal.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from this change. Customers may need to validate the function and feature change once the post-change system is available.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RMS3JC080	932472	H17952-004	H24094-203	H17952-005	H24094-204

PCN Revision History:

Date of Revision:
August 31, 2017

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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